

Article ID: 1003 - 6326(2004)06 - 1117 - 06

# Layered structure of Ni-Al multi-layered metal intermetallic composites fabricated by in-situ reactions<sup>①</sup>

ZHANG Jiao(张 佼)<sup>1, 2</sup>, SUN Bao-de(孙宝德)<sup>1</sup>, XIA Zhen-hai(夏振海)<sup>3</sup>  
(1. State Key Laboratory of Metal Matrix Composites, Shanghai Jiaotong University,  
Shanghai 200030, China;  
2. School of Materials Science and Engineering, Hebei University of Technology,  
Tianjin 300132, China;  
3. Division of Engineering, Brown University, Providence, USA)

**Abstract:** Systematical experiments were done at five temperature levels: 500 °C, 630 °C, 900 °C, 1 000 °C and 1 100 °C to illuminate the layer structure of the multi-layered metal intermetallic composites of Ni-Al system that were fabricated by a previously reported simple and cost-effective method. The analysis of back scattering photos and XRD examination of specimens reveal that the look like single compound layer is composed of several different components. The primary phase produced during reaction is Ni<sub>2</sub>Al<sub>3</sub> and there exists a like two-phase field between NiAl<sub>3</sub> and Ni<sub>2</sub>Al<sub>3</sub>. The high temperature phases like NiAl and Ni<sub>3</sub>Al are also found at low temperature. The results indicate that the key driving force of in-situ reaction is not temperature, but the atom concentration.

**Key words:** intermetallic compound; in-situ reaction; layered structure; back scattering photo

**CLC number:** TG 111.6

**Document code:** A

## 1 INTRODUCTION

Most intermetallic compounds have high strength, excellent oxidation resistance at high temperature<sup>[1-6]</sup>. However, the inherent low ductility and low fracture toughness at ambient temperature limit them to be used in engineering. Some of them, such as ferrite aluminides, nickel aluminides and titanium aluminides, were in depth studied for practical utilization. In order to improve their comprehensive mechanical properties, various methods had been attempted<sup>[7-9]</sup>. The recent research on laminated structure composites enlightened us to adopt a new method to improve the properties of nickel aluminides. ZHU et al<sup>[10]</sup> reported that the diffusion reactions between nickel and aluminum were triggered at high temperature, and the produced compound layers jointed the metal layers together. Similar work was reported in Ref. [11]. In our previous work<sup>[12]</sup>, the laminated metal intermetallic composites had been fabricated by interlayer in-situ reactions, and had been proved to have great improvement in properties over the constituent elements. Though the previous works<sup>[10-12]</sup> showed the distinct layered structures, the details of structure were not made clear. In this paper a systematical experiment was designed to reveal the details of the compound layers. The results indicate that the single compound layer under SEM is actually composed of several different compounds, and the number of compound lay-

ers is maximal when the reaction temperature is under the melting point of Ni<sub>2</sub>Al<sub>3</sub>. Further more, the high temperature phases are also found in low temperature samples.

## 2 EXPERIMENTAL

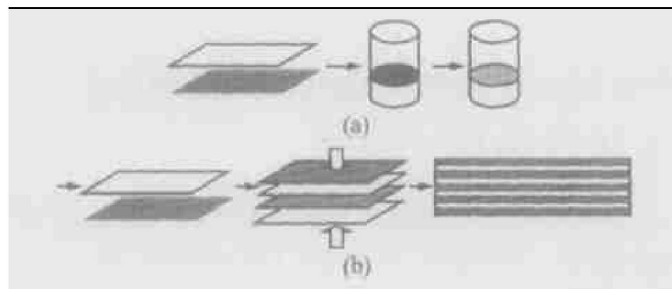
### 2.1 Preparation of samples

In the experiments, foils of commercially pure nickel ( $\geq 99.98\%$ , mass fraction) and aluminum ( $\geq 99.93\%$ , mass fraction) were used to stack alternative Ni and Al layers. The thickness of aluminum foils was 0.1 mm and nickel foils 0.05 mm. Ni and Al foils were cut to size of 10 mm  $\times$  80 mm. About 50 foils of Ni and Al were stacked alternatively. The flow chart of the process is introduced in details in Fig. 1. The pieces of nickel foil and aluminum foil were pre-cleaned in 5% alkaline solution first to remove oil and other organic contaminants, then in 15% - 20% hydrochloric acid. After being rinsed by distilled water and dried at ambient temperature, the sheets were stacked alternately into Ni/Al multi-layer samples which were pressed with a pressure of 200 MPa, and held in a graphite mould, so that the metal sheets could keep contact with each other closely.

The pressed multi-layer samples were then treated in a self-made vacuum furnace (as shown in Fig. 2) with a vacuum of  $5 \times 10^{-3}$  Pa.

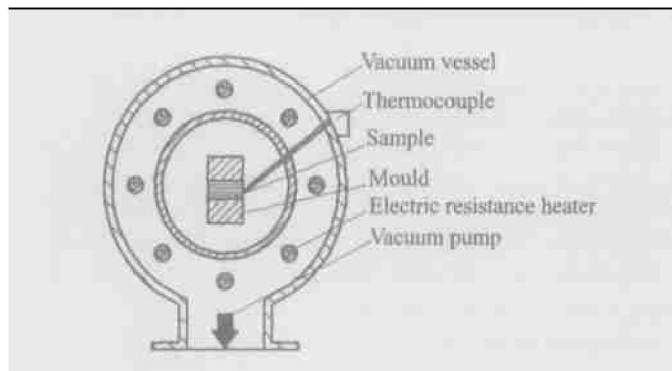
① Received date: 2004 - 03 - 29; Accepted date: 2004 - 08 - 29

Correspondence: SUN Bao-de, Professor, PhD; Tel: + 86 21-62834534; E-mail: bdsun@sjtu.edu.cn



**Fig. 1** Flow chart of pretreatment

- (a) —Cleaned in alkaline first, then in acid;  
(b) —Dried, laminated and then pressed into sample



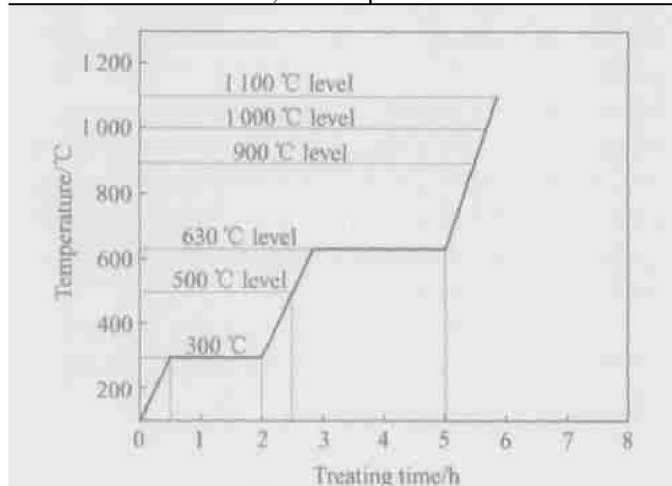
**Fig. 2** Sketch of equipment

## 2.2 Fabrication

In order to study the reaction status and results under different temperatures, the treating method was divided into five levels: 500 °C, 630 °C, 900 °C, 1 000 °C and 1 100 °C. The temperature was elevated and held strictly along the specified technological routes that were shown in Fig. 3. The pre-treatment at 300 °C was a necessary procedure before fabrication<sup>[12]</sup>. When the experiments were finished, the samples cooled in furnace in vacuum environment. According to our previous results<sup>[12, 13]</sup>, the original aluminum layers had been used up after 2 h treating at 630 °C. Therefore, the aluminum would not melt or leak out when the temperature went up to 900 °C, 1 000 °C and 1 100 °C.

## 2.3 Microstructure determination

After fabrication, the specimens were cut and



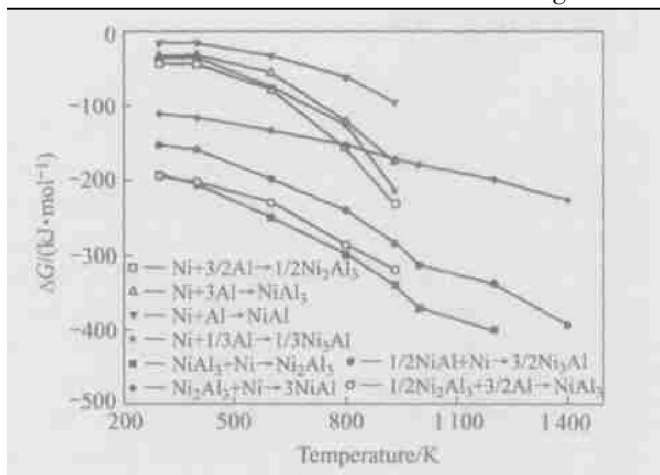
**Fig. 3** Technical routes of elevating temperature

polished. The details of layered microstructure were examined under PHILIP505 scanning electronic microscope (SEM) by back scattering observation. The phase presence was determined with D/max-2500 X-ray diffractometer (XRD). Quantitative energy dispersive spectroscopy (EDS) attached to SEM was used to measure the atom composition of points on the polished cross-sectional surface. Through comparing EDS results with Ni-Al binary phase diagram, phases were ascertained exactly<sup>[13]</sup>.

## 3 RESULTS AND DISCUSSION

### 3.1 Microstructure of laminates

According to the phase diagram, there are some complex reactions and phase transformations in Ni-Al system. The transformations and diffusion reactions are different under different conditions, such as treating temperature and time. In fact, the phase transformations are determined by the reaction dynamics. According to the data in Ref. [14], the Gibbs free energy of possible reactions between Ni and Al are calculated and shown in Fig. 4.

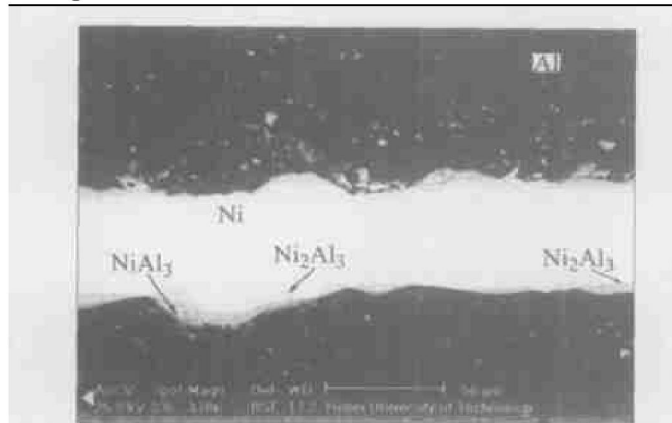


**Fig. 4** Relationship between Gibbs free energy and temperature of reactions

Among the direct reactions between Ni-Al atoms, the Gibbs free energy of the reaction  $\text{Ni} + 3/2\text{Al} \rightarrow 1/2\text{Ni}_2\text{Al}_3$  is the lowest. So  $\text{Ni}_2\text{Al}_3$  phase should be the original phase in in-situ reaction, and the second phase  $\text{NiAl}_3$  should be generated by the reaction  $\text{Ni}_2\text{Al}_3 + 3\text{Al} \rightarrow 2\text{NiAl}_3$ .

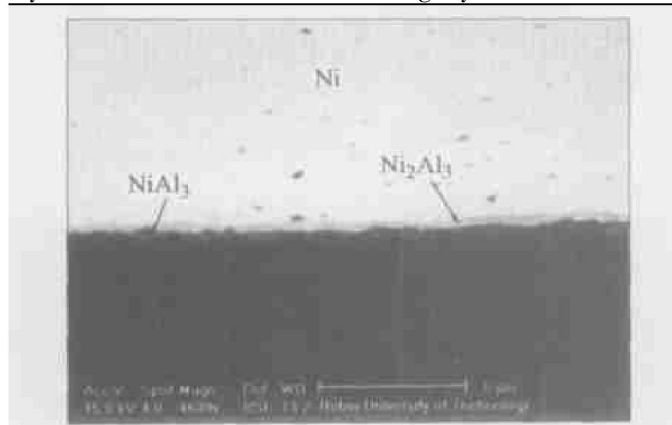
In order to prove the conclusion, the special experiment was designed additionally. In the experiment, the sample heated to 630 °C directly without pre-treatment for 30 min and isothermally annealed for 20 min, was scanned by SEM. The back scattering photo is shown in Fig. 5. Due to the plastic deformation of Al foils during cold compressing, the interface between Ni-Al foils became rough, and the level of reaction was not uniform.

Near the “peak top” of interface between Ni and Al foils, there exists only one phase  $\text{Ni}_2\text{Al}_3$ , contrariwise, two compound layers at the “valley bottom” as indicated in the figure.



**Fig. 5** Primary phase and secondly produced phase

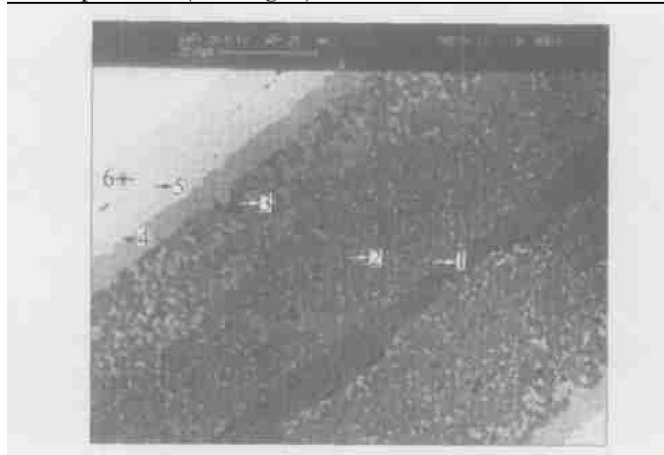
In order to avoid the high temperature oxidation, the samples of each level were treated at 300 °C for 90 min before they were heated to 500 °C, 630 °C, 900 °C and 1 100 °C. The sectional photo of pre-treating only sample is shown in Fig. 6. Though the total thickness of the compound layers is less than 1  $\mu\text{m}$ , the intermetallic layers bond the two kinds of foils tightly.



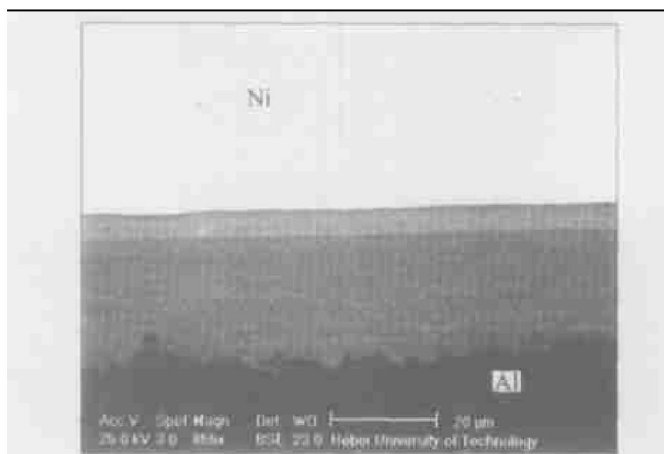
**Fig. 6** Back scattering photo of pre-treatment sample at 300 °C

From the Ni-Al binary phase diagram, it can be found that the composition of  $\text{NiAl}_3$  phase is a fixed value, all the others have a composition range. So there must be a concentration transition region between  $\text{Ni}_2\text{Al}_3$  and Al phase when the thickness of  $\text{NiAl}_3$  layer becomes big enough. According to the diffusion theory, there is never two-phase field during the diffusion reaction.  $\text{Ni}_2\text{Al}_3$  is a kind of long-range order solid solution, and it can form under the appropriate external conditions. If the concentrations of Ni and Al atoms meet the suitable proportion in  $\text{NiAl}_3$  phase,  $\text{Ni}_2\text{Al}_3$  forms and comes out of the  $\text{NiAl}_3$  phase (see Fig. 7). The like “two-phase field” found in  $\text{NiAl}_3$  of 630 °C experiments can be considered many  $\text{Ni}_2\text{Al}_3$  “islands” located in

the “sea” of  $\text{NiAl}_3$ . This phenomena also exists in 500 °C level specimens (see Fig. 8).



**Fig. 7** Back scattering photo of 630 °C/ 210 min specimen

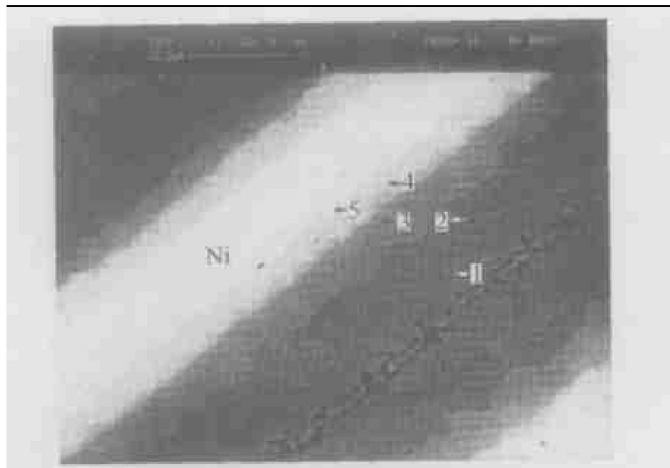


**Fig. 8** Back scattering photo of 500 °C/ 180 min specimen

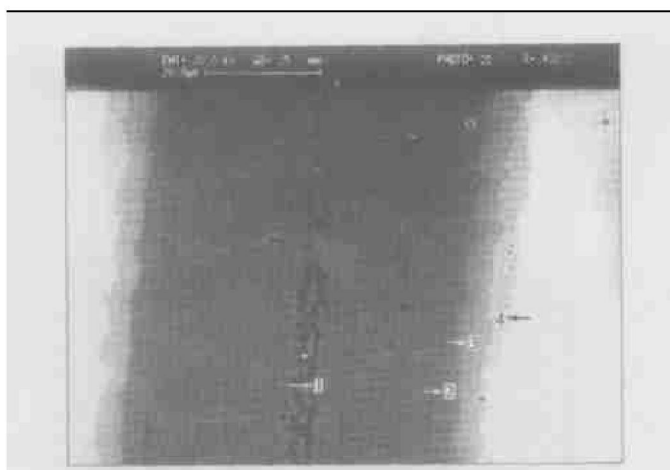
At low reaction temperature, only two layers were generated between Ni and Al foils while the reactions lasted shortly (see Fig. 5 and Fig. 6). At 630 °C, after the appropriate reaction time, the sample can present the typical layered structure referred in the Ref. [12] (see Fig. 3(b) and Fig. 9 there). However, scanned by the back scattering in SEM, the typical compound layered structure can be distinguished more clearly, revealed in Fig. 7 and Fig. 9.

With the reaction continuing, the nickel concentration of compound layers will increase. Consequently, the high temperature phase  $\text{NiAl}$ ,  $\text{Ni}_3\text{Al}$  and even the  $\text{Ni}_5\text{Al}_3$  appear near the Ni layer (see Fig. 9). Their presence indicates that the key driving force of in-situ reaction is atom concentration, instead of the temperature.

With the increase of reaction temperature, the components of compound layer change accordingly. At 900 °C level,  $\text{NiAl}_3$  combines with Ni atoms and changes into  $\text{Ni}_2\text{Al}_3$ . Similarly,  $\text{Ni}_2\text{Al}_3$  changes into  $\text{NiAl}$  at 1 000 °C and 1 100 °C. The section microstructures of the three levels specimens are shown in Figs. 10, 11 and 12, respectively. In fact, the vacuum in the experiments is not



**Fig. 9** Back scattering photo of 630 °C/ 600 min specimen



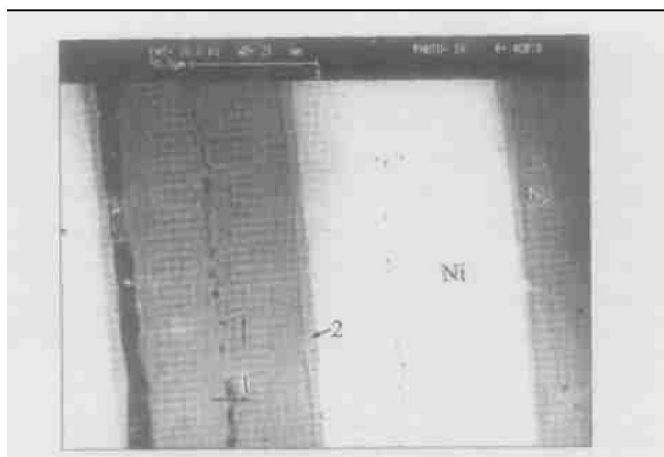
**Fig. 10** Back scattering photo of 900 °C/ 120 min specimen

high ( $5 \times 10^{-3}$  Pa), and the high temperature intensifies the oxidation. The produced oxides are pushed at the growing interface and finally accumulated. Another influence of high temperature appears obviously in 1 100 °C level specimens. Because of the large difference of elongation between Ni and the compound, the stress caused by the expand of Ni layers breaks the compound layers, where the cracks are arrowed in Fig. 11. As a result, the tensile strength of the composites drops<sup>[13]</sup>.

The XRD examination of total samples is



**Fig. 11** Back scattering photo of 1 000 °C/ 360 min specimen



**Fig. 12** Back scattering photo of 1 100 °C/ 120 min specimen

shown in Fig. 13. The composition of the points arrowed in figures were measured by EDS and listed in Table 1, respectively.

$\text{Ni}_5\text{Al}_3$  born between  $\text{NiAl}$  and  $\text{Ni}_3\text{Al}$  layers is easy to decompose. The thickness of  $\text{Ni}_5\text{Al}_3$  layer is small and nonuniform. Though its characteristic peaks can not be detected in XRD, it appears clearly in back scattering photo (Fig. 9). And the EDS results also show its presence.

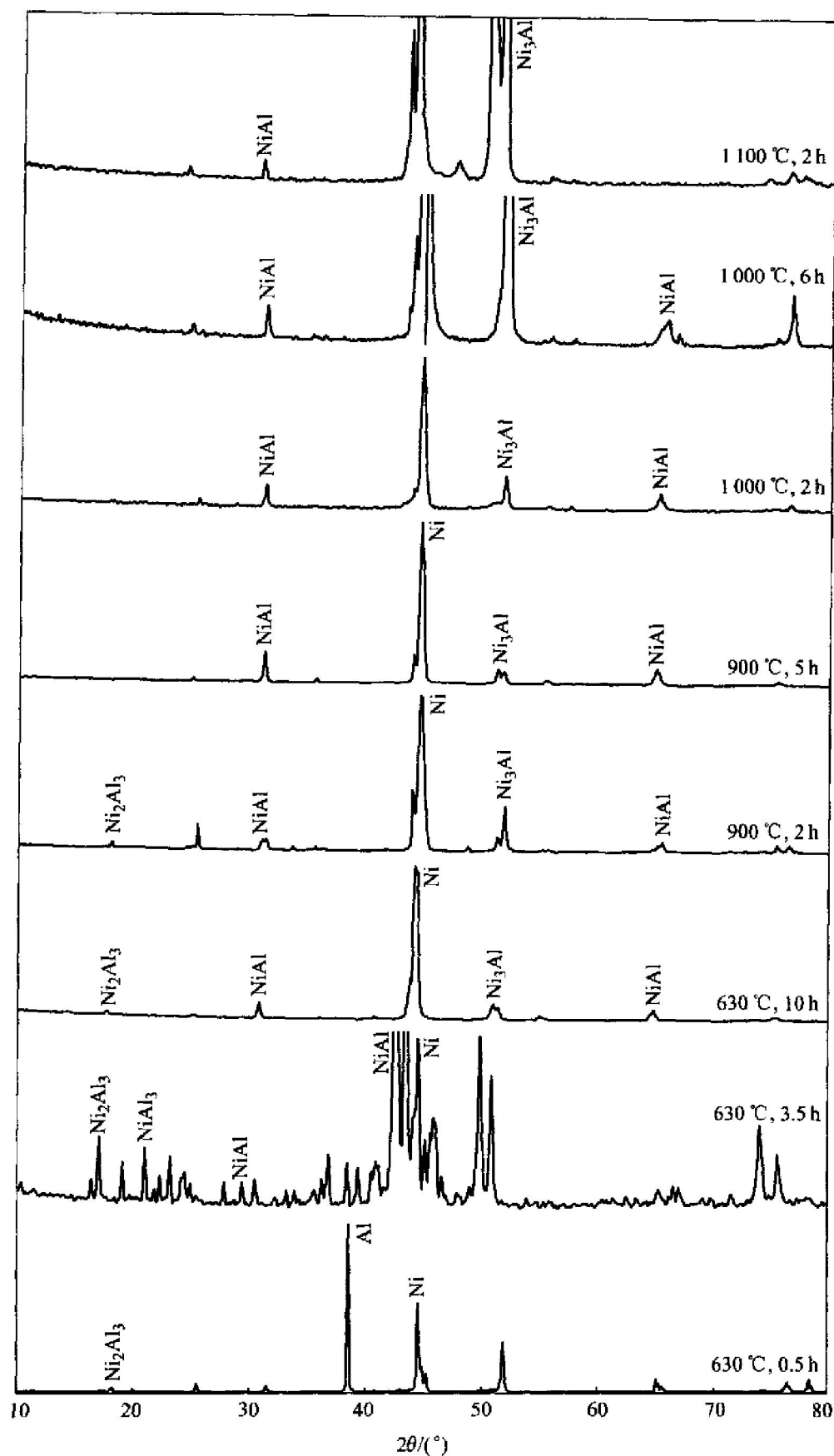
### 3.2 Growth of intermetallic compound layer

In different level experiments, either the dis-

**Table 1** Composition of points measured by EDS

Points	Points in Fig. 7		Points in Fig. 9		Points in Fig. 10		Points in Fig. 11		Points in Fig. 12	
	$x(\text{Ni}) / \%$	Phase	$x(\text{Ni}) / \%$	Phase	$x(\text{Ni}) / \%$	Phase	$x(\text{Ni}) / \%$	Phase	$x(\text{Ni}) / \%$	Phase
1	25	$\text{NiAl}_3$	41	$\text{Ni}_2\text{Al}_3$	34	$\text{Ni}_2\text{Al}_3$	58	$\text{NiAl}$	62	$\text{NiAl}$
2	29	$\alpha$	41	$\text{Ni}_2\text{Al}_3$	40	$\text{Ni}_2\text{Al}_3$	60	$\text{NiAl}$	78	$\text{Ni}_3\text{Al}$
3	33	$\alpha$	44	$\text{NiAl}$	53	$\text{NiAl}$	75	$\text{Ni}_3\text{Al}$		
4	41	$\text{Ni}_2\text{Al}_3$	64	$\text{Ni}_5\text{Al}_3$	68	$\text{Ni}_3\text{Al}$				
5	42	$\text{NiAl}$	74	$\text{Ni}_3\text{Al}$						
6	62	$\text{NiAl}$								

$\alpha$  represents  $\text{NiAl}_3 + \text{Ni}_2\text{Al}_3$



**Fig. 13** XRD patterns of samples

tribution or the thickness of the compound layers is different. Though the compound layer consists of several different phases, all the phase transformations and growth of layers are controlled by atoms diffusion of Ni and Al. Because the interface between layers is plane, the diffusion

process can be considered as one dimension. Any growth of interphase layer must be determined by the amount of atoms that diffuse through the existing compound layers<sup>[15]</sup>. Then Eqn. (1) holds.

$$dn = - dt \cdot D \cdot q \cdot \Delta C / y \quad (1)$$

where  $dn$  is the amount of atoms passing through sectional area  $q$  during  $dt$  time,  $\Delta C/y$  is the slope of the solute concentration along layer thickness  $y$ ,  $D$  is diffusion coefficient. Because the value of  $\Delta C/y$  in compound layer keeps constant, then

$$dn = a \cdot q \cdot dy \quad (2)$$

where  $dy$  is the increase of layer thickness,  $a$  is a parameter that has dimension equal to concentration. Combining Eqn. (1) with Eqn. (2) yields

$$dt \cdot D \cdot \Delta C / y = a \cdot dy$$

Then

$$D \cdot t \cdot \Delta C / a = y^2 / 2$$

This is to say that the thickness of compound layer  $y$  is a function of  $t^{1/2}$ , i. e. their growth follows exponential rule. In 630 °C experiments, due to the presence of the like “two phase field”, it is very difficult to separate the thickness of  $\text{Ni}_2\text{Al}_3$  and  $\text{NiAl}_3$  phase independently. However, the thickness of the whole compound layer is recorded in Fig. 14. Basically, the growth of compound layer coincides with the above equation.

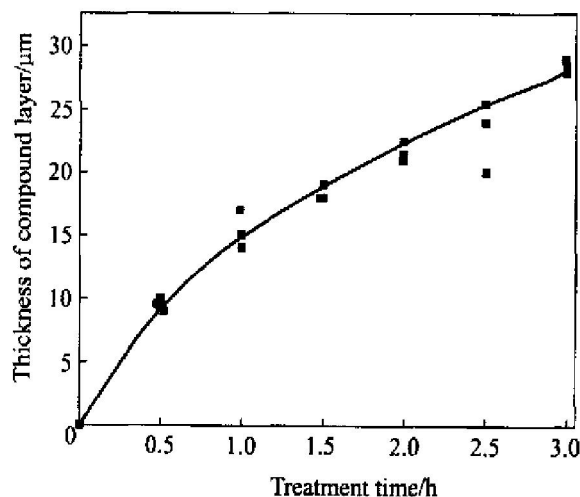


Fig. 14 Relation between thickness of compound layer and treating time in 630 °C experiments

## 4 CONCLUSIONS

1) The high temperature phases  $\text{NiAl}$  and  $\text{Ni}_3\text{Al}$  can be obtained under lower temperature treatment. It can be drawn that the key driving force of in-situ reactions is atom concentration, and temperature plays a subordinate role under certain conditions. The high temperature oxidation will also be avoided if decreasing the reaction temperature.

2) If the compound layer of laminated composite consists of  $\text{NiAl}_3$  phase, the microstructure of the laminated material is unstable.  $\text{NiAl}_3$  phase will combine with Ni atoms and transform into  $\text{Ni}_2\text{Al}_3$  when the ambient temper-

ature is near or higher than the treating temperature. The microstructure obtained at higher temperature or with long treating time is nevertheless comparatively stable. If the vacuum degree of equipment is improved, the treating temperature should increase accordingly.

3) The primary phase is  $\text{Ni}_2\text{Al}_3$  during the diffusion reaction between  $\text{Ni}$  and  $\text{Al}$ . The original  $\text{NiAl}_3$  is transformed from  $\text{Ni}_2\text{Al}_3$ . When the diffusion of Ni and Al atoms continues at low temperature, the “two-phase field” appears consequently.

## REFERENCES

- [1] Stoloff N S, Liu C T. Emerging applications of intermetallics [J]. *Intermetallics*, 2000, 8(9): 1313 - 1320.
- [2] Schulson E M. Hydrogen-boron interaction and its effect on the ductility and fracture of  $\text{Ni}_3\text{Al}$  [J]. *Scripta Materialia*, 1998, 38(5): 845 - 846.
- [3] Banerjee R, Thompson G B. Sputter deposited nanocrystalline  $\text{Ni}_{25}\text{Al}$  alloy thin films and  $\text{Ni}/\text{Ni}_3\text{Al}$  multilayers [J]. *Thin Solid Films*, 2003, 424(1): 93 - 98.
- [4] Ito S, Teiji Y. Machinability of  $\text{Ni}_3\text{Al}$ -based intermetallic compounds [J]. *Journal of Materials Processing*, 1997, 63(1): 181 - 186.
- [5] Brennan P C, Kao W G. Processing and heat treatment effects on an  $\text{Al}_2\text{O}_3/\text{Ni}_3\text{Al}$  composite [J]. *Materials and Manufacturing Processes*, 1994, 9(2): 281 - 294.
- [6] Phillipps A J, Clegg W J. Failure of layered ceramics in bending and tension [J]. *Composites*, 1994, 25: 524 - 533.
- [7] HU J, LIN D L. Nonequilibrium grain boundary core segregation of boron and magnesium in  $\text{Ni}_3\text{Al}$  [J]. *Acta Metall Sin*, 2002, 38(8): 829 - 834. (in Chinese)
- [8] Cermak J, Ruvickova J. Influence of boron doping and stoichiometry upon the Ni grain boundary diffusion in  $\text{Ni}_3\text{Al}$  intermetallic [J]. *Scripta Materialia*, 1997, 37(1): 31 - 35.
- [9] GU Y F, LIN D L. High temperature deformation behaviors of directionally solidified  $\text{Ni}_3\text{Al}$  alloy [J]. *Acta Metall Sin*, 1996, 32(11): 1144 - 1148. (in Chinese)
- [10] ZHU P, LI C M, LIU C T. Combustion reaction in multilayered nickel and aluminum foils [J]. *Material Sci Eng A*, 1997, 239 - 240: 532 - 539.
- [11] Mumtaz K, Echigoya J, Nakata C. Effect of cold rolling and subsequent annealing on hot pressed  $\text{Ni}/\text{Al}$  laminates [J]. *Journal of Materials Science*, 2001, 36: 3981 - 3987.
- [12] XIA Z H, LIU J H. Fabrication of laminated metal intermetallic composites by interlayer in situ reaction [J]. *Journal of Materials Science*, 1999, 34(15): 3731 - 3735.
- [13] ZHANG J, XIA Z H. Research of  $\text{Ni}/\text{Al}$  system metal/intermetallic compounds layered composite diffusion growth [J]. *Journal of Hebei University of Technology*, 1999, 28(5): 36 - 39. (in Chinese)
- [14] LIAN G, DONG Y J. Manual of Abiothermodynamics [M]. Shenyang: Northeastern University Press, 1993. (in Chinese)
- [15] HE S A. Diffusion in Metal and Alloy [M]. Beijing: Science Press, 1958. (in Chinese)

(Edited by YUAN Sai-qian)